

FJY3002R

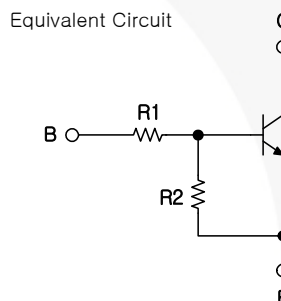
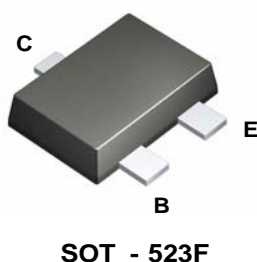
NPN Epitaxial Silicon Transistor

Features

- Switching Circuit, Inverter, Interface Circuit, Driver Circuit
- Built-in Bias Resistor ($R_1 = 10\text{ k}\Omega$, $R_2 = 10\text{ k}\Omega$)
- Complement to FJY4002R

Application

- Switching Application (Integrated Bias Resistor)



Ordering Information

Part Number	Top Mark	Package	Packing Method
FJY3002R	S02	SOT-523F	Tape and Reel

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Units
V_{CBO}	Collector-Base Voltage	50	V
V_{CEO}	Collector-Emitter Voltage	50	V
V_{EBO}	Emitter-Base Voltage	10	V
I_C	Collector Current	100	mA
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Junction Temperature	150	$^\circ\text{C}$

Thermal Characteristics⁽¹⁾

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Unit
P_D	Power Dissipation	200	mW
	Derate Above $T_A = 25^\circ\text{C}$	1.60	mW/ $^\circ\text{C}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	625	$^\circ\text{C/W}$

Note:

1. PCB Board Size: FR-4 76 x 114 x 0.6T mm³(3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Electrical Characteristics⁽²⁾

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
$V_{(BR)CBO}$	Collector-Emitter Breakdown Voltage	$I_C = 10\ \mu\text{A}$, $I_E = 0$	50			V
$V_{(BR)CEO}$	Collector-Base Breakdown Voltage	$I_C = 100\ \mu\text{A}$, $I_B = 0$	50			V
I_{CBO}	Collector-Cut-Off Current	$V_{CB} = 40\ \text{V}$, $I_E = 0$			0.1	μA
h_{FE}	DC Current Gain	$V_{CE} = 5\ \text{V}$, $I_C = 5\ \text{mA}$	30			
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 10\ \text{mA}$, $I_B = 0.5\ \text{mA}$			0.3	V
f_T	Current Gain - Bandwidth Product	$V_{CE} = 10\ \text{V}$, $I_C = 5\ \text{mA}$		250		MHz
C_{cb}	Output Capacitance	$V_{CB} = 10\ \text{V}$, $I_E = 0$, $f = 1.0\ \text{MHz}$		3.7		pF
$V_{I(off)}$	Input Off Voltage	$V_{CE} = 5\ \text{V}$, $I_C = 100\ \mu\text{A}$			0.5	V
$V_{I(on)}$	Input On Voltage	$V_{CE} = 0.3\ \text{V}$, $I_C = 10\ \text{mA}$	3			V
R_1	Input Resistor		7	10	13	k Ω
R_1 / R_2	Resistor Ratio		0.9	1.0	1.1	

Note:

2. Pulse test: pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.

Typical Performance Characteristics

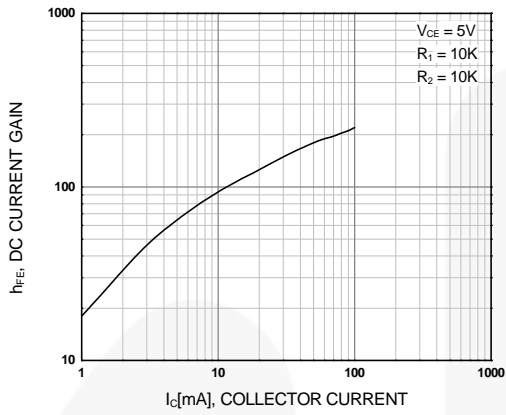


Figure 1. DC Current Gain

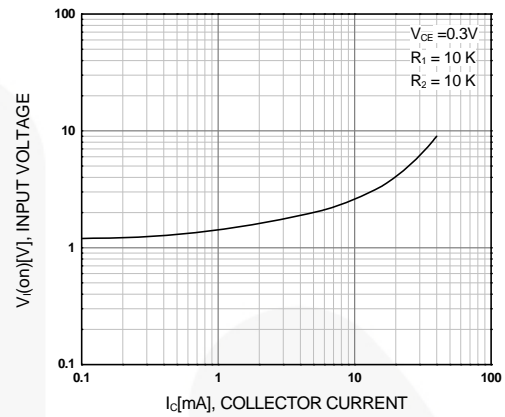


Figure 2. Input On Voltage

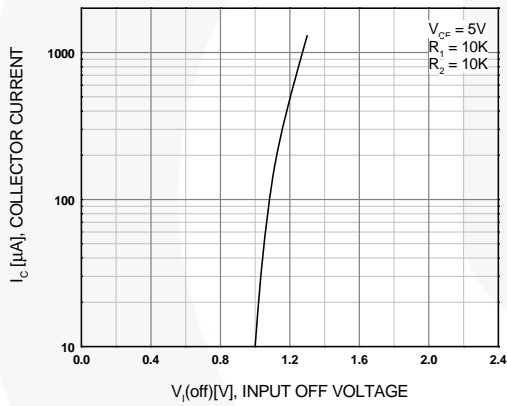


Figure 3. Input Off Voltage

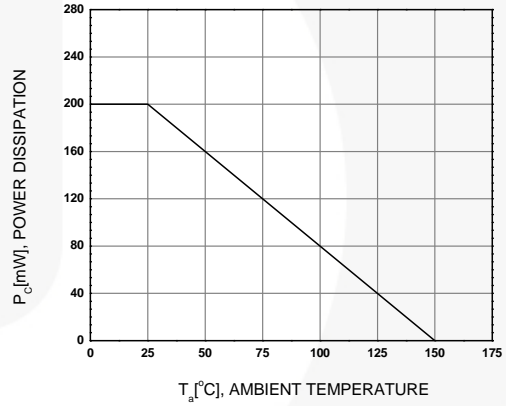
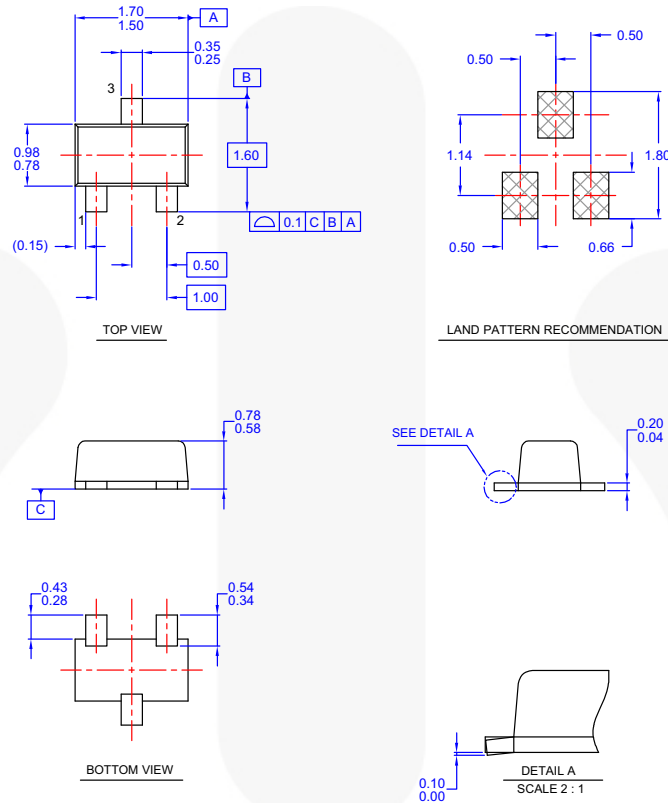


Figure 4. Power Derating

Physical Dimensions

SOT-523F



- NOTES:
- A) THIS PACKAGE CONFORMS TO EIAJ SC89 PACKAGING STANDARD.
 - B) ALL DIMENSIONS ARE IN MILLIMETERS.
 - C) DRAWING CONFORMS TO ASME Y14.5M-1994
 - D) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

MAD03ArevA

Figure 5. 3-LEAD, SC89, EIAJ-SC89, 0.88 MM WIDE, SOT523F (ACTIVE)

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Rev. I66